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4GBJ6005 THRU 4GBJ610

Glass Passivated Bridge Rectifiers

Reverse Voltage - 50 to 1000 Volts
Forward Current - 6.0 Amperes

Features

- Glass passivated chip
- Low forward voltage drop
- Ideal for printed circuit board
- High surge current capability
- Meet UL flammability classification 94V-0

Mechanical Data

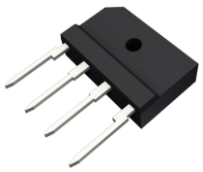
- Polarity: Symbol marked on body
- Mounting position: Any

Note: Products with logo HY® or HY are made by HY Electronic (Cayman) Limited.

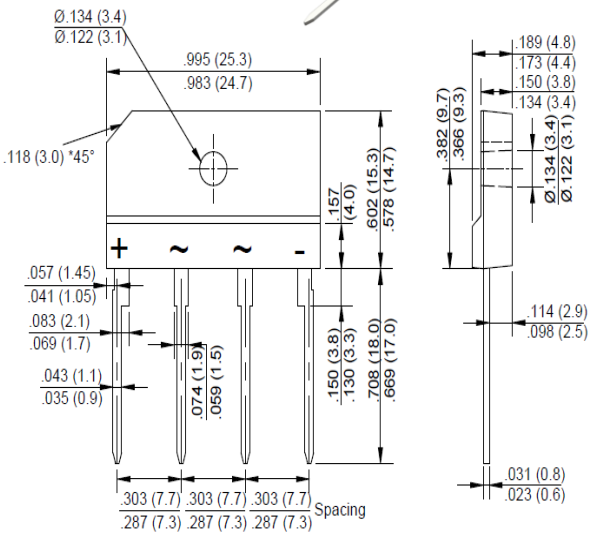
Applications

- General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.

4GBJ



RoHS COMPLIANT



Package Outline Dimensions in Inches (Millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25℃ ambient temperature unless otherwise specified.
Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristics	Symbol	4GBJ 6005	4GBJ 601	4GBJ 602	4GBJ 604	4GBJ 606	4GBJ 608	4GBJ 610	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (with heatsink Note 2)	$I_{(AV)}$	6.0							A
@ TC=100℃ (without heatsink)		2.8							
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave, Superimposed on Rated Load (JEDEC Method)	I_{FSM}	170							A
I^2t Rating for Fusing (t<8.3mS)	I^2t	120							A^2s
Peak Forward Voltage per Diode at 3A DC	V_F	1.0							V
Maximum DC Reverse Current at Rated @T_J=25℃	I_R	5.0							μA
DC Blocking Voltage per Diode @T_J=125℃		500							
Typical Junction Capacitance per Diode (Note1)	C_J	55							pF
Typical Thermal Resistance to case （with heatsink (Note2) ）	$R_{\theta JC}$	1.8							℃/W
Operating Junction Temperature Range	T_J	-55 to +150							℃
Storage Temperature Range	T_{STG}	-55 to +150							℃

Notes: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
2.Device mounted on 75mm*75mm*1.6mm Cu plate heatsink.
3.The typical data above is for reference only

Fig. 1 - Forward Current Derating Curve

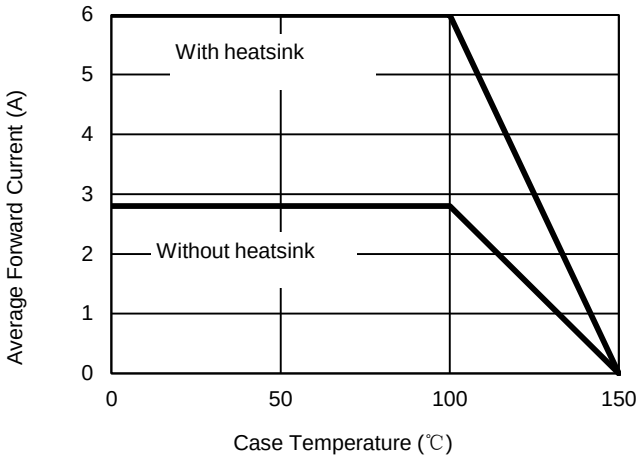


Fig. 2 - Maximum Non-Repetitive Surge Current

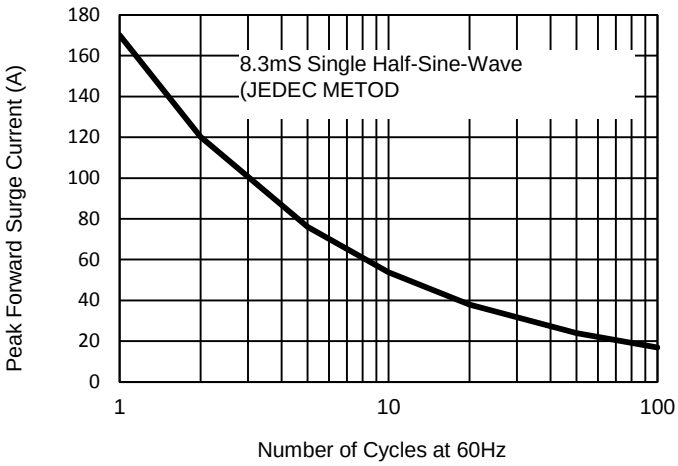


Fig. 3 - Typical Reverse Characteristics

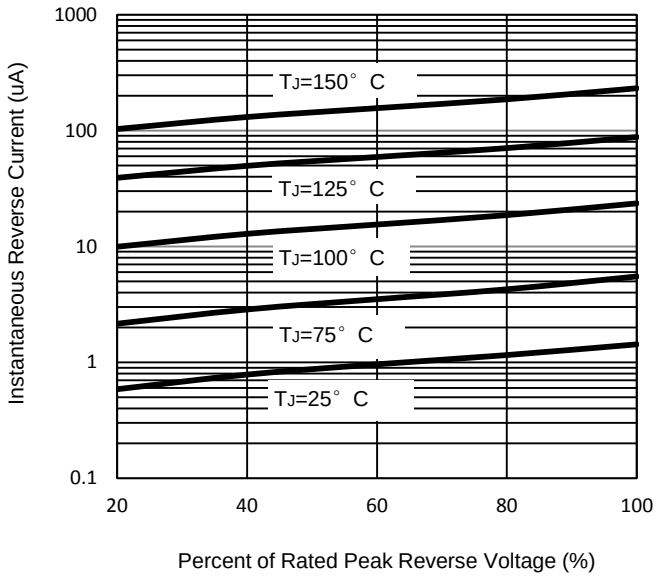


Fig. 4 - Typical Forward Characteristics

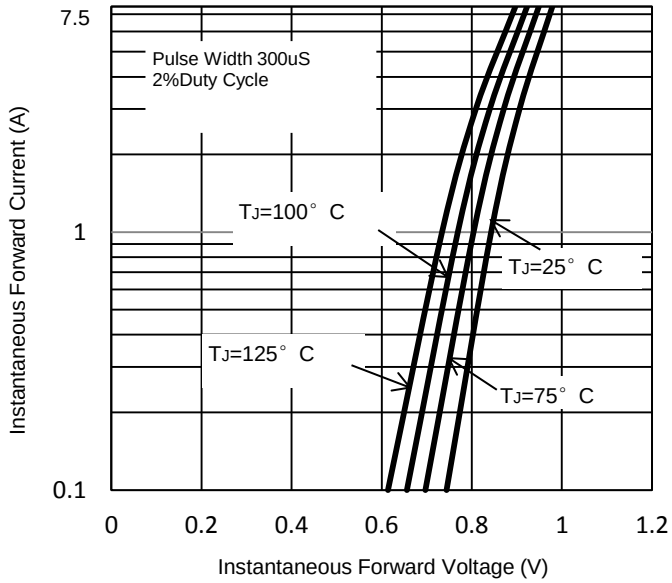
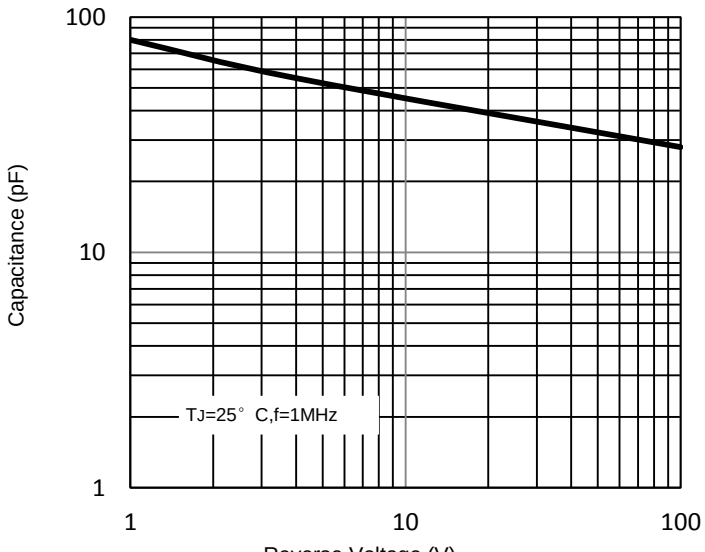


Fig. 5 - Typical Junction Capacitance



The curve above is for reference only.

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